

“The Challenges of Logistics Technology - Opportunities and Innovation” Conference

It is our great pleasure to announce that the Logistics & Transportation (LT) Division and Manufacturing & Industrial (MI) Division of the Hong Kong Institution of Engineers will join force to organize the “The Challenges of Logistics Technology - Opportunities and Innovation” conference on 27th September, 2018, in Hong Kong.

The conference will take place in the Hong Kong Convention and Exhibition Centre (Room: S221). The half day (afternoon) event features prominent speakers from academic institutes, technology professionals and key business leaders from renowned international corporations. Market insights and innovations at the forefront of smart logistics, automation and technology will be shared during the conference.

Date, Time & Place

Date: 27 September 2018 (Thursday)
Time: 13:30 - 17:30
Organizer: The Hong Kong Institution of Engineers
Venue: Hong Kong Convention and Exhibition Centre (Room: S221)
Fee: Free
Language: Presentation in English, Cantonese or Putonghua (Powerpoint in English)

Programme Highlights

More than three hundred attendees are expected to join the conference, of which they include HK Legislative Council Representative, senior ranked officers from the HKSAR Government Transport Department, business leaders, specialists from both the public and private sectors, logistics associations' leaders, engineers and industrial practitioners. We are confident that the “The Challenges of Logistics Technology - Opportunities and Innovation” conference will be an excellent platform for all professions to share and exchange views and insights.

Guests of Honour

- Frank Chan, JP - Secretary for Transport & Housing, the HKSAR
- Ir. Dr Hon Lo Wai-kwok, SBS, MH, JP - Legislative Councillor for Engineering Constituency, the HKSAR

Speakers

- Kelvin Ko - Group Vice President, BPS Global Group
- Dixin Chen - Chief Engineer, Sinomach Materials Handling Research Institute, Beijing
- Eric Chong - President & CEO, Siemens Ltd.
- Kevin Chan - Chairman, Store Friendly Self Storage Group
- Simon Wong - CEO, LSCM R&D Centre (under HKSAR ITC)

Registration & Enquiries

This conference is free of charge and prior registration is required. Applications will be accepted on a first-come-first-served basis. Please click this link to register our Conference: <https://goo.gl/forms/OweP4xMuoaamajRyA3>
Your registration by **13 September 2018 (Thursday)** will be much appreciated. If you have any queries regarding the conference, please do not hesitate to contact Secretariat of Conference Organizing Committee, Gloria Lam at (852) 3898 1386 or Jo Ng at (852) 3898 1315.

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Programme

13:30 – 14:00	Registration
14:00 – 14:05	Opening Remarks: Ir Dr. Stephen Lam Chairman, LT Division of the Hong Kong Institution of Engineers (2018/19)
14:05 – 14:20	Speech by Guest of Honour: Frank CHAN, JP Secretary for Transport & Housing, the HKSAR
14:20 – 14:30	Speech by Guest of Honour: Ir Dr Hon LO Wai-kwok, SBS, MH, JP Legislative Councillor for Engineering Constituency, the HKSAR
14:30 – 14:35	Photo-taking Session
14:35 – 16:05	Keynote Session (1): Kelvin KO Group Vice President, BPS Global Group Keynote Session (2): Dixin CHEN Chief Engineer, Sinomach Materials Handling Research Institute, Beijing Keynote Session (3): Eric CHONG President & CEO, Siemens Ltd.
16:05 – 16:25	Refreshment Break and Robot Exhibition
16:25 – 17:05	Keynote Session (4): Kevin CHAN Chairman, Store Friendly Self Storage Group Keynote Session (5): Simon WONG CEO, LSCM R&D Centre (under HKSAR ITC)
17:05 – 17:25	Panel Discussion and Q&A Session
17:25 – 17:30	Closing Remarks: Ir Dr. Ritz LAU Chairman, MI Division of the Hong Kong Institution of Engineers (2018/19)
17:30	End of Conference

*Remarks: Programme rundown is subject to change without prior notice.

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